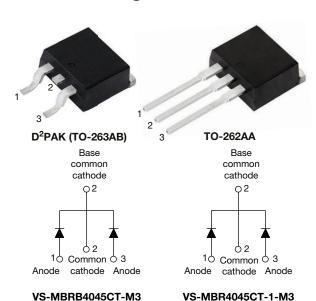
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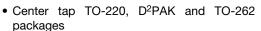
High Performance Schottky Rectifier, 2 x 20 A



PRIMARY CHARACTERISTICS						
I _{F(AV)} 2 x 20 A						
V _R	45 V					
V _F at I _F	0.58 V					
I _{RM} max.	95 mA at 125 °C					
T _J max.	150 °C					
E _{AS}	20 mJ					
Package	D ² PAK (TO-263AB), TO-262AA					
Circuit configuration	Common cathode					

FEATURES

- 150 °C T_{.I} operation
- Low forward voltage drop
- High frequency operation





- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

The center tap Schottky rectifier has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS									
SYMBOL	CHARACTERISTICS VALUES UNITS								
I _{F(AV)}	Rectangular waveform (per device)	40	А						
I _{FRM}	T _C = 118 °C (per leg)	40	_ ^						
V _{RRM}		45	V						
I _{FSM}	t _p = 5 μs sine	900	Α						
V _F	20 A _{pk} , T _J = 125 °C	0.58	V						
T _J	Range	-65 to +150	°C						

VOLTAGE RATINGS							
PARAMETER SYMBOL VS-MBRB4045CT-M3 UNITS							
Maximum DC reverse voltage	V_{R}	45	V				
Maximum working peak reverse voltage	V_{RWM}	V _{RWM} 45					



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ABSOLUTE MAXIMUM RATINGS								
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS			
Maximum average per le		$H = I_{\text{E}/\Lambda \Lambda \Lambda} = I_{\text{C}} = 118 ^{\circ}\text{C}$. rated $V_{\text{P}} = I_{\text{C}} $		20	A			
forward current per device	e IF(AV)			40				
Peak repetitive forward current per leg	I _{FRM}	Rated V _R , square wave, 20 kHz, T _C = 118 °C		40				
Maximum peak one cycle non-repetitiv		5 μs sine or 3 μs rect. pulse	Following any rated load condition and with	900				
peak surge current per leg	IFSM	10 ms sine or 6 ms rect. pulse		210				
Non-repetitive avalanche energy per le	g E _{AS}	$T_J = 25 ^{\circ}\text{C}, I_{AS} = 3 \text{A}, L = 4.4 \text{mH}$		20	mJ			
Repetitive avalanche current per leg	I _{AR}	Current decaying linearly to zero in 1 μ s Frequency limited by T _J maximum V _A = 1.5 x V _R typical		3	А			

ELECTRICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CO	TEST CONDITIONS				
Maximum forward voltage drop		20 A	T _{.1} = 25 °C	0.60			
	V _{FM} ⁽¹⁾	40 A	1j=25 C	0.78	V		
	VFM ('')	20 A	T 105 %C	0.58			
		40 A	T _J = 125 °C	0.75			
		T _J = 25 °C		1	mA		
Maximum instantaneous reverse current	I _{RM} ⁽¹⁾	T _J = 100 °C	Rated DC voltage	50			
reverse current		T _J = 125 °C		95			
Maximum junction capacitance	C _T	$V_R = 5 V_{DC}$ (test signal range 100 kHz to 1 MHz), 25 °C		900	pF		
Typical series inductance	L _S	Measured from top of term	8.0	nH			
Maximum voltage rate of change	dV/dt	Rated V _R 10 000 V/					

Note

 $^{^{(1)}\,}$ Pulse width $<300~\mu s,$ duty cycle <2~%

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	SYMBOL TEST CONDITIONS		UNITS			
Maximum junction temperature range	TJ		-65 to 150	°C			
Maximum storage temperature range	T _{Stg}		-65 to 175	C			
Maximum thermal resistance, junction to case per leg	R _{thJC}	DC operation	1.5				
Typical thermal resistance, case to heatsink	R _{thCS}	Mounting surface, smooth, and greased (Only for TO-220)	0.50	°C/W			
Maximum thermal resistance, junction to ambient	R _{thJA}	DC operation (For D ² PAK and TO-262)	50				
Approximate weight			2	g			
Approximate weight			0.07	OZ.			
Mounting torque			6 (5)	kgf · cm			
Mounting torque maximum		Non-lubricated threads	12 (10)	(lbf \cdot in)			
Marking daving		Case style D ² PAK (TO-263AB)	MBRB4	1045CT			
Marking device		Case style TO-262	MBR40	45CT-1			

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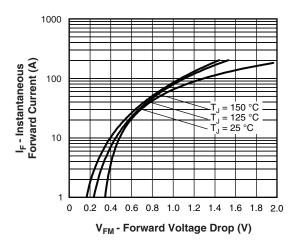


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

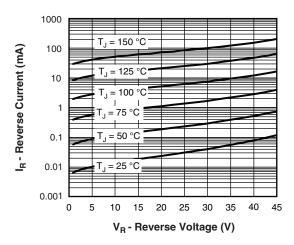


Fig. 2 - Typical Values of Reverse Current vs.Reverse Voltage (Per Leg)

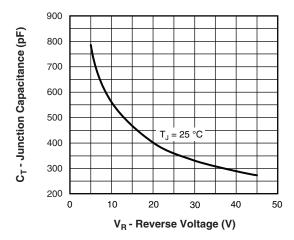


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

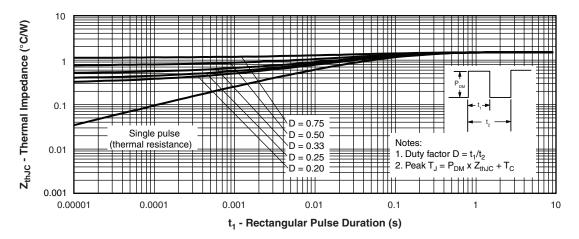


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics (Per Leg)

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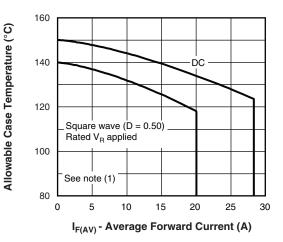


Fig. 5 - Maximum Allowable Case Temperature vs.
Average Forward Current

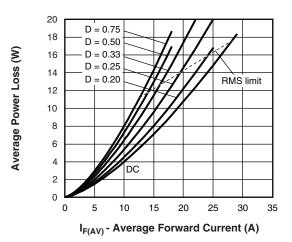


Fig. 6 - Forward Power Loss Characteristics

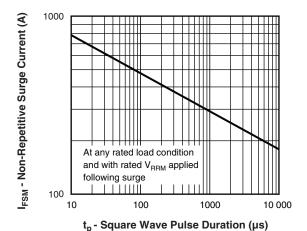


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

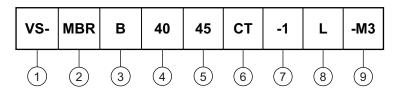
Note

 $\begin{array}{ll} \text{(1)} & \text{Formula used: } T_C = T_J - (Pd + Pd_{REV}) \times R_{th,JC}; \\ Pd = \text{forward power loss} = I_{F(AV)} \times V_{FM} \text{ at } (I_{F(AV)}/D) \text{ (see fig. 6)}; \\ Pd_{REV} = \text{inverse power loss} = V_{R1} \times I_R \text{ (1 - D)}; I_R \text{ at } V_{R1} = \text{rated } V_R \text{ (1 - D)}; I_R \text{ (2 - C)}; \\ I_R \text{ (2 - C)} & I_R \text{ (2 - C)}; I_R \text{ (3 - C)}; I_R \text{ (4 - C)$

Vishay Semiconductors

ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Essential part number

• None = TO-262 7 = -1

- Current rating (40 = 40 A)

5 - Voltage rating (45 = 45 V)

6 - CT = essential part number

- • None = D^2PAK 3 = B

• -1 = TO-262 **3** None

8 - • None = tube

• L = tape and reel (left oriented - for D²PAK only)

• R = tape and reel (right oriented - for D2PAK only)

9 - -M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

ORDERING INFORMATION (Example)							
PREFERRED P/N	BASE QUANTITY	PACKAGING DESCRIPTION					
VS-MBRB4045CTL-M3	800	13" diameter plastic tape and reel					
VS-MBRB4045CT-M3	50	Antistatic plastic tubes					
VS-MBRB4045CTR-M3	800	13" diameter plastic tape and reel					
VS-MBR4045CT-1-M3	50	Antistatic plastic tubes					

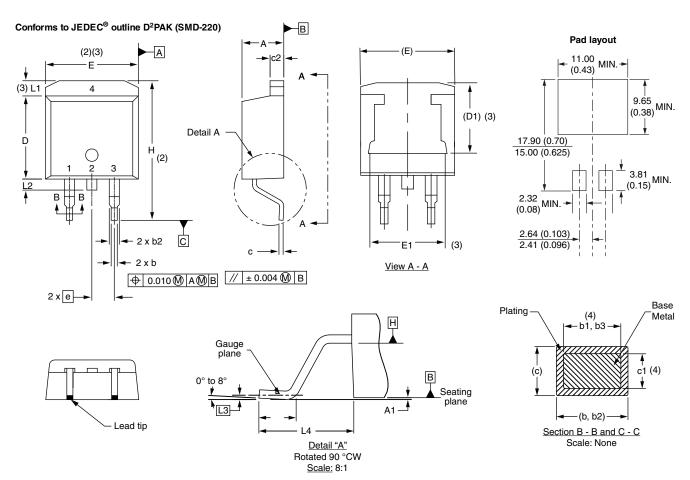
LINKS TO RELATED DOCUMENTS						
D ² PAK (TO-263AB) <u>www.vishay.com/doc?96164</u>						
Dimensions —	TO-262AA	www.vishay.com/doc?96165				
Dout moulcing information	D ² PAK (TO-263AB)	www.vishay.com/doc?95444				
Part marking information —	TO-262AA	www.vishay.com/doc?95443				
Packaging information		www.vishay.com/doc?96424				
SPICE model		www.vishav.com/doc?95296				



Vishay Semiconductors

D²PAK

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INC	INCHES		SYMBOL	MILLIM	ETERS	INC	HES	NOTES
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOIES	STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190		D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010		Е	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039		E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4	е	2.54	BSC	0.100	BSC	
b2	1.14	1.78	0.045	0.070		Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4	L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029		L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4	L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065		L3	0.25	BSC	0.010	BSC	
D	8.51	9.65	0.335	0.380	2	L4	4.78	5.28	0.188	0.208	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inches
- (7) Outline conforms to JEDEC® outline TO-263AB

Revision: 13-Jul-17 Document Number: 96164

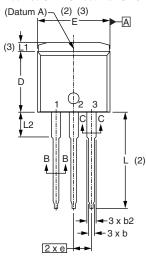


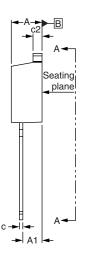
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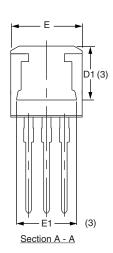
TO-262AA

DIMENSIONS in millimeters and inches

Modified JEDEC® outline TO-262







⊕ 0.010 **M** A**M** B

Lead assignments

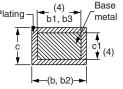


Diodes

1. - Anode (two die)/open (one die)

2., 4. - Cathode

3. - Anode



Section B - B and C - C Scale: None

SYMBOL	MILLIN	METERS	INC	INCHES			
STINIBUL	MIN.	MAX.	MIN.	MAX.	NOTES		
Α	4.06	4.83	0.160	0.190			
A1	2.03	3.02	0.080	0.119			
b	0.51	0.99	0.020	0.039			
b1	0.51	0.89	0.020	0.035	4		
b2	1.14	1.78	0.045	0.070			
b3	1.14	1.73	0.045	0.068	4		
С	0.38	0.74	0.015	0.029			
c1	0.38	0.58	0.015	0.023	4		
c2	1.14	1.65	0.045	0.065			
D	8.51	9.65	0.335	0.380	2		
D1	6.86	8.00	0.270	0.315	3		
Е	9.65	10.67	0.380	0.420	2, 3		
E1	7.90	8.80	0.311	0.346	3		
е	2.54 BSC		0.100) BSC			
L	13.46	14.10	0.530	0.555			
L1	-	1.65	-	0.065	3		
L2	3.56	3.71	0.140	0.146			

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
 (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- Controlling dimension: inches
- Outline conform to JEDEC® TO-262 except A1 (max.), b (min., max.), b1 (min.), b2 (max.), c (min.), c1(min.), c2 (max.), D (min.), E (max.), L1 (max.), L2 (min., max.)

Revision: 30-Nov-17 Document Number: 96165





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